

BNC Conn. Series

Material & Finish

Body: Zinc Alloy Nickel Plating

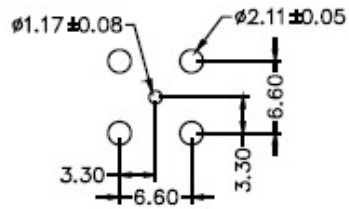
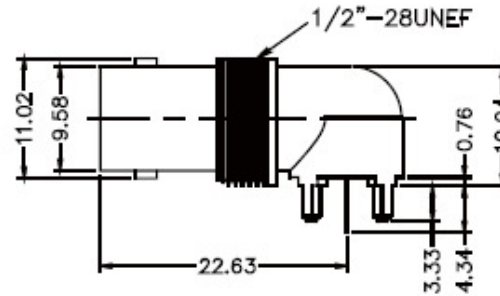
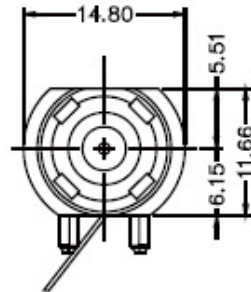
Insulator: TEFLON

Center Contact : Phosphor Bronze / Gold Plating

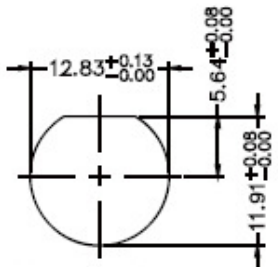
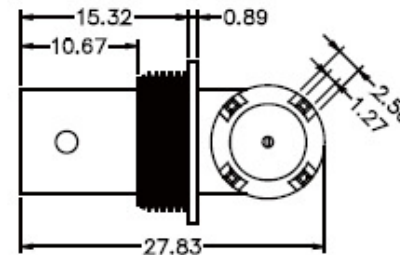
Mounting Post: Phosphor Bronze / Tin Plating



BNCR004-F **GW-L**
 5:50 Ω 7:75 Ω



RECOMMENDED PC BOARD LAYOUT
 WITHOUT MOUNTING POSTS



RECOMMENDED MOUNTING HOLE
 MAXIMUM PANEL THICKNESS: 5.5MM

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